

Multi-DC/DC Color LED Kit Hardware

This reference guide goes over kit contents and the kit hardware details and explains the functions and locations of jumpers and connectors present on the board. This document supersedes all of the documents available for the hardware of this kit.

Contents

1	Introduction	2
2	Getting Familiar With the Kit	3
3	Hardware Overview.....	4
4	Hardware Resource Mapping	7

List of Figures

1	Picture of the Multi-DC/DC Color LED Kit Board (TMDSRGBLEDKIT)	2
2	Block Diagram for an LED Lighting Application.....	4
3	Multi-DC/DC Color LED Board Macro Block Locations	5
4	Multi-DC/DC Color LED Kit Circuit Diagram	8
5	Multi-DC/DC Color LED Board Jumpers, Connectors, and Switches Locations	10

List of Tables

1	Power Board Specifications (at Maximum)	3
2	LED Panel Specifications	3
3	Macro Block Locations Legend	5
4	Boot Options.....	6
5	PWM and ADC Resource Allocation	7
6	Description of Jumpers, Connectors, and Switches.....	9

1 Introduction

The multi-DC/DC color LED kit provides a great way to learn and experiment with using a single MCU to accurately control a series of LED strings and efficiently control the power stages needed to make the LEDs work.

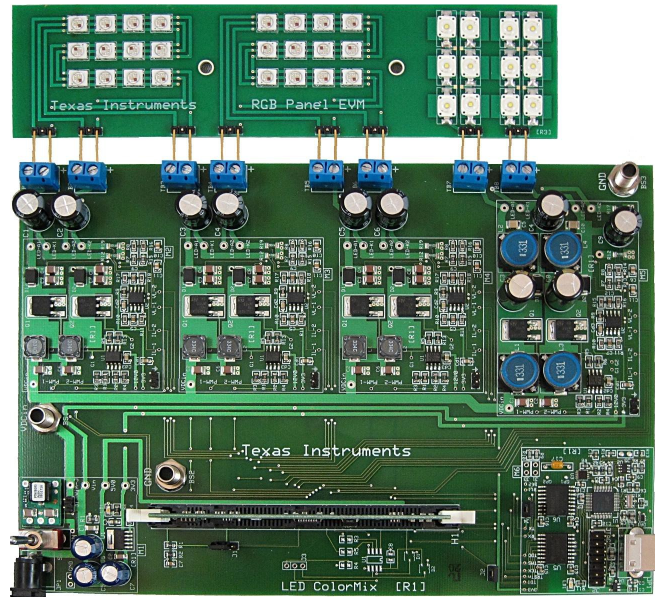


Figure 1. Picture of the Multi-DC/DC Color LED Kit Board (TMDSRGBLEDKIT)

WARNING

This evaluation module (EVM) is meant to be operated in a lab environment only and is not considered by TI to be a finished end-product fit for general consumer use.

This equipment operates at voltages and currents that can result in electrical shock, fire hazard and personal injury if not properly handled or applied. Use equipment with the necessary caution and appropriate safeguards employed to avoid personal injury or property damage.

2 Getting Familiar With the Kit

2.1 Kit Contents

The kit consists of:

- Multi-DC/DC Color LED Kit power board
- Piccolo™ F28027 controlCARD
- Color RGB LED panel with diffuser cover
- 12-V power adapter
- USB cable
- USB drive with graphical user interface (GUI) executable and Code Composer Studio™ (CCS) v4 software

The board can accept any of the C2000™ series controlCARDS. An F28027 control card is shipped with the kit. Some software changes may be necessary to have the board work with a different controlCARD.

2.2 Kit Features

The kit has the following features:

- Power board with eight independently controlled power stages (6×Boost, 2×SEPIC), each capable of providing both voltage and current feedback
- LED panel with two RGB LED strings and two white LED strings
- Onboard isolated JTAG emulation
- Isolated universal asynchronous receiver/transmitter (UART) communication through the serial communications interface (SCI) peripheral and FTDI chip
- Hardware developer's package is available and includes schematics, bill of materials (BOM), Gerber files, and so on

2.3 Kit Specifications

The multi-DC/DC color LED kit has the following specifications: ⁽¹⁾

⁽¹⁾ Hardware component-based limitations.

Table 1. Power Board Specifications (at Maximum⁽¹⁾)

INPUT	OUTPUT
36-V DC 350 mA per stage	50-V DC 650 mA per stage

⁽¹⁾ The DC input for the board should be chosen based on the specifications of the attached LED panel. When using the LED panel included in the kit, if the demo-mode jumper [M1]-J1 is not populated, a DC input range of 12 to 18 V is recommended. If the demo-mode jumper is populated, use a 12-V DC input to prevent damage to board components.

Table 2. LED Panel Specifications

RGB LED STRINGS	WHITE LED STRINGS
12 LEDs 400 mA per color (max)	6 LEDs 1 A (max)

3 Hardware Overview

Figure 2 illustrates an LED lighting system running from DC power.

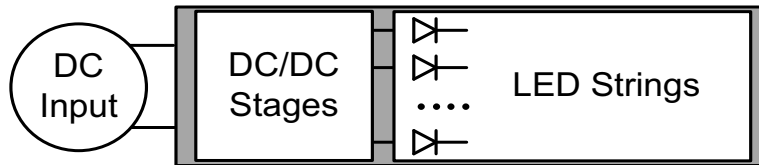


Figure 2. Block Diagram for an LED Lighting Application

There are multiple ways of controlling LEDs. On this board, use the C2000 to control a separate DC supply for each of the LED strings. Control the brightness by using the C2000 by varying the output power of each DC/DC stage independently, which allows us to control the average current passing through each LED string. Since average current is roughly proportional to lumen output, each LED string's brightness is controlled.

3.1 Macro Blocks

The multi-DC/DC color LED board is divided into functional groups referred to as macro blocks. The following is a list of the macro blocks present on the board and a brief description of each:

Main board [Main]—Contains the controlCARD socket, power connectors, jumpers, and the routing of signals between the controlCARD and the macro blocks. This section includes any area outside of other defined macro blocks.

DC-PwrEntry macro [M1]—Generates the 12-V, 5-V, and 3.3-V DC power rails from a 12-V DC supply included with the kit or an external DC power supply.

Dual boost macro [M2],[M3], and [M4]—Consists of two independent boost DC/DC conversion stages with voltage and output current feedback, per macro instance.

Isolated-USB-to-JTAG macro [M6]—Provides an onboard isolated JTAG connection through USB to the host as well as isolated SCI (UART) communication.

Dual SEPIC macro [M5]—Consists of two independent SEPIC DC/DC conversion stages with voltage and output current feedback.

Figure 3 illustrates the position of these macro blocks on the board. The use of a macro block approach for different power stages enables easy debug and testing of one stage at a time. All of the pulse width modulator (PWM) and analog-to-digital converter (ADC) signals have designated test points on the board, which makes it easy for an application developer to not only debug but try out new algorithms and strategies.

Nomenclature: A component on the board is referred to with a macro number in the brackets followed by a dash and the reference number. For example, [M2]-J1 refers to the jumper J1 located in the macro M2, and [Main]-J1 refers to the jumper J1 located on the board outside of the defined macro blocks.

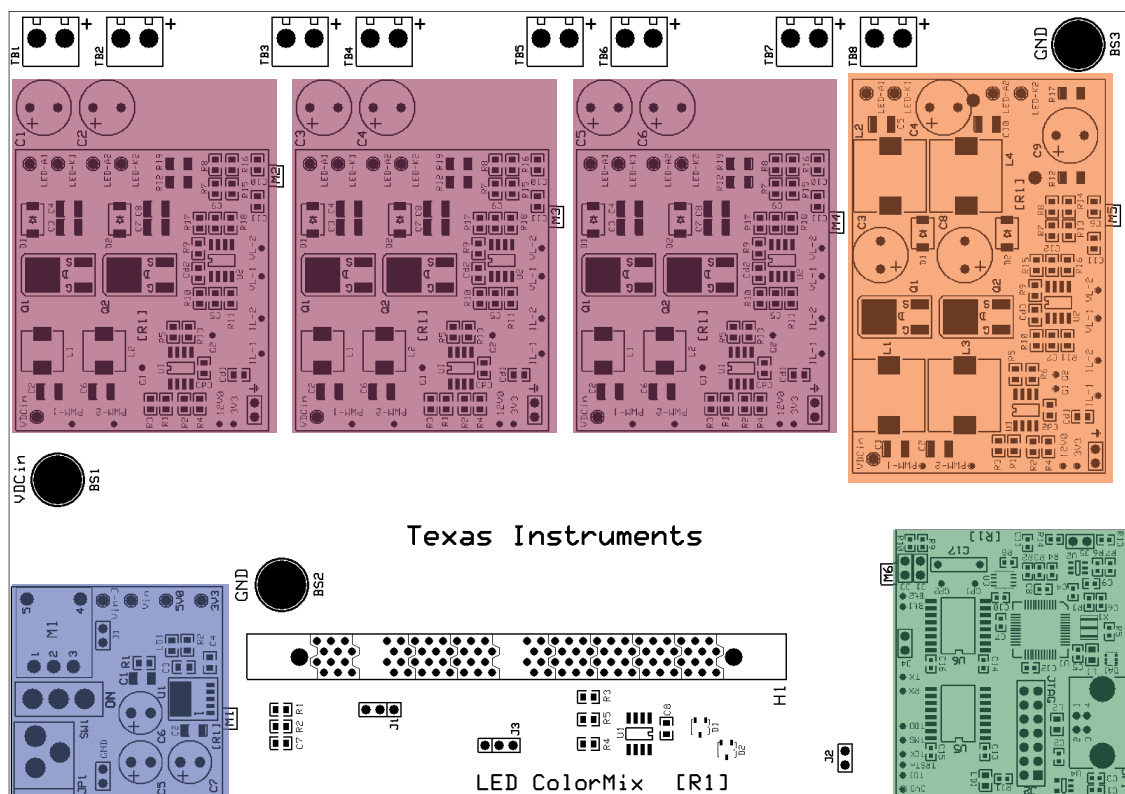


Figure 3. Multi-DC/DC Color LED Board Macro Block Locations

Table 3. Macro Block Locations Legend

[Main] – controlCARD socket, power connectors, and jumpers
[M1] – 12-V, 5-V, and 3.3-V DC power rails
[M6] – Isolated JTAG and SCI (UART) communication via USB
[M2],[M3], and [M4] – Two independent Boost stages, per macro instance
[M5] – Two independent SEPIC stages

3.2 Powering the Board

The DC/DC LED Lighting board has two separate power domains and two major modes of operation. The two power domains are the primary power rail, which feeds the eight DC/DC power stages, and the auxiliary power rail, which powers all of the support chips along with the MCU. The question of which mode of operation to use depends on if the board is being used to evaluate or experiment.

WARNING

Always use caution when using the board's electronics.

- Demo Mode – used to quickly show how the boards functions. All power used by the board is provided from a single 12-V DC power supply. The CE marked, 12-V, 2-A power supply that is included with the Multi-DC/DC Color LED Kit is ideal for this mode.
 - Demo-mode enable jumper [M1]-J1 should be populated
 - A 12-V DC supply should be connected to either [M1]-JP1 or [Main]-BS1, but not both
- Experimentation Mode – uses two different power supplies to minimize the risk of damage caused while experimenting. The primary and auxiliary power rails will each use a separate power supply. This mode allows the user to verify PWM output and ADC feedback signals before energizing the DC/DC power stages and helps protect the MCU if a fault occurs on the primary power rail. This mode also allows for more experimentation with how the eight DC/DC power stages work under different input voltages.
 - Demo-mode enable jumper [M1]-J1 should not be populated
 - A 12-V DC supply should be connected to [M1]-JP1
 - A separate 12-18V DC supply (or some other voltage chosen based on desired input/output power), should be connected to [Main]-TB1
 - [M1]-SW1 controls power to the MCU and support chips

3.3 Boot Modes

Table 4 describes the jumper and switch settings that are needed for booting from Flash and SCI for the board.

Table 4. Boot Options

DEVICE	BOOT FROM FLASH	BOOT FROM SCI (USING ISO JTAG MACRO)
F2802x	SW1 on controlCARD <ul style="list-style-type: none"> • Position 1 = 1 • Position 2 = 1 Remove the jumper [Main]-J2	SW1 on controlCARD <ul style="list-style-type: none"> • Position 1 = 1 • Position 2 = 0 Depopulate R10 on controlCARD Remove the jumper [Main]-J2 Populate the jumper [M6]-J4
F2803x	SW2 on controlCARD <ul style="list-style-type: none"> • Position 1 = 1 • Position 2 = 1 Remove the jumper [Main]-J2	SW2 on controlCARD <ul style="list-style-type: none"> • Position 1 = 1 • Position 2 = 0 SW3 on controlCARD should be off Remove the jumper [Main]-J2 Populate the jumper [M6]-J4

3.4 GUI Connection

The FTDI chip present on the board can be used as an isolated SCI for communicating with a host (for example, a PC). The following jumper settings must be done to enable this connection:

1. Populate jumper [M6]-J4.
2. Remove jumper [Main]-J2.
3. For F28035, put SW3 on the F28035 controlCARD to the *OFF* position. For F28027, verify that R10 on the controlCARD is removed.
4. Connect a USB cable from [M6]-JP1 to the host.

NOTE: To boot from Flash and connect using the GUI, use the proper *Boot from Flash* settings described in [Table 4](#).

3.5 Ground Levels and Safety

Do not touch any part of the board or components connected to the board while energized.

The power stages on the board are individually rated. Make sure that these ratings (such as the voltage, current and power levels) are well understood and complied with prior to connecting these power blocks together and energizing the board or simulation.

4 Hardware Resource Mapping

4.1 Resource Allocation

[Figure 4](#) shows the various stages of the board in a circuit diagram format and illustrates the major connections and feedback values being mapped to the C2000 MCU. [Table 5](#) lists these resources. It is important to note that not all resources are available on every C2000 MCU. For example, Piccolo F28027 devices only have 13 ADC channels, so not all feedback signals are available for use even if they are routed to the DIM100 controlCARD socket. For more detailed information, see the schematics and device-specific data sheets.

Table 5. PWM and ADC Resource Allocation

MACRO NAME			SIGNAL NAME	PWM/ADC CHANNEL	DESCRIPTION
Main Board	[Main]	VDCin- meas	VDCin- meas	ADC-B4	Input voltage sense muxed with V-Led-4B
Dual Boost	[M2]	PWM-1	PWM-1A	PWM-1A	Boost 1 PWM signal
		PWM-2	PWM-1B	PWM-1B	Boost 2 PWM signal
		Vfb-1	V-Led-1A	ADC-B1	Boost 1 output voltage sense
		Vfb-2	V-Led-1B	ADC-B2	Boost 2 output voltage sense
		Ifb-1	I-Led-1A	ADC-A2	Boost 1 output current sense
		Ifb-2	I-Led-1B	ADC-A0	Boost 2 output current sense
Dual Boost	[M3]	PWM-1	PWM-2A	PWM-2A	Boost 3 PWM signal
		PWM-2	PWM-2B	PWM-2B	Boost 4 PWM signal
		Vfb-1	V-Led-2A	ADC-B3	Boost 3 output voltage sense
		Vfb-2	V-Led-2B		Boost 4 output voltage sense
		Ifb-1	I-Led-2A	ADC-A4	Boost 3 output current sense
		Ifb-2	I-Led-2B	ADC-A1	Boost 4 output current sense

Table 5. PWM and ADC Resource Allocation (continued)

MACRO NAME			SIGNAL NAME	PWM/ADC CHANNEL	DESCRIPTION
Dual Boost	[M4]	PWM-1	PWM-3A	PWM-3A	Boost 5 PWM signal
		PWM-2	PWM-3B	PWM-3B	Boost 6 PWM signal
		Vfb-1	V-Led-3A	ADC-B5	Boost 5 output voltage sense
		Vfb-2	V-Led-3B		Boost 6 output voltage sense
		lfb-1	I-Led-3A	ADC-A6	Boost 5 output current sense
		lfb-2	I-Led-3B	ADC-A3	Boost 6 output current sense
Dual SEPIC	[M5]	PWM-1	PWM-4A	PWM-4A	SEPIC 1 PWM signal
		PWM-2	PWM-4B	PWM-4B	SEPIC 2 PWM signal
		Vfb-1	V-Led-4A	ADC-B7	SEPIC 1 output voltage sense
		Vfb-2	V-Led-4B	ADC-B4	SEPIC 2 output voltage sense muxed with VDCin-meas
		lfb-1	I-Led-4A	ADC-B6	SEPIC 1 output current sense
		lfb-2	I-Led-4B	ADC-A7	SEPIC 2 output current sense

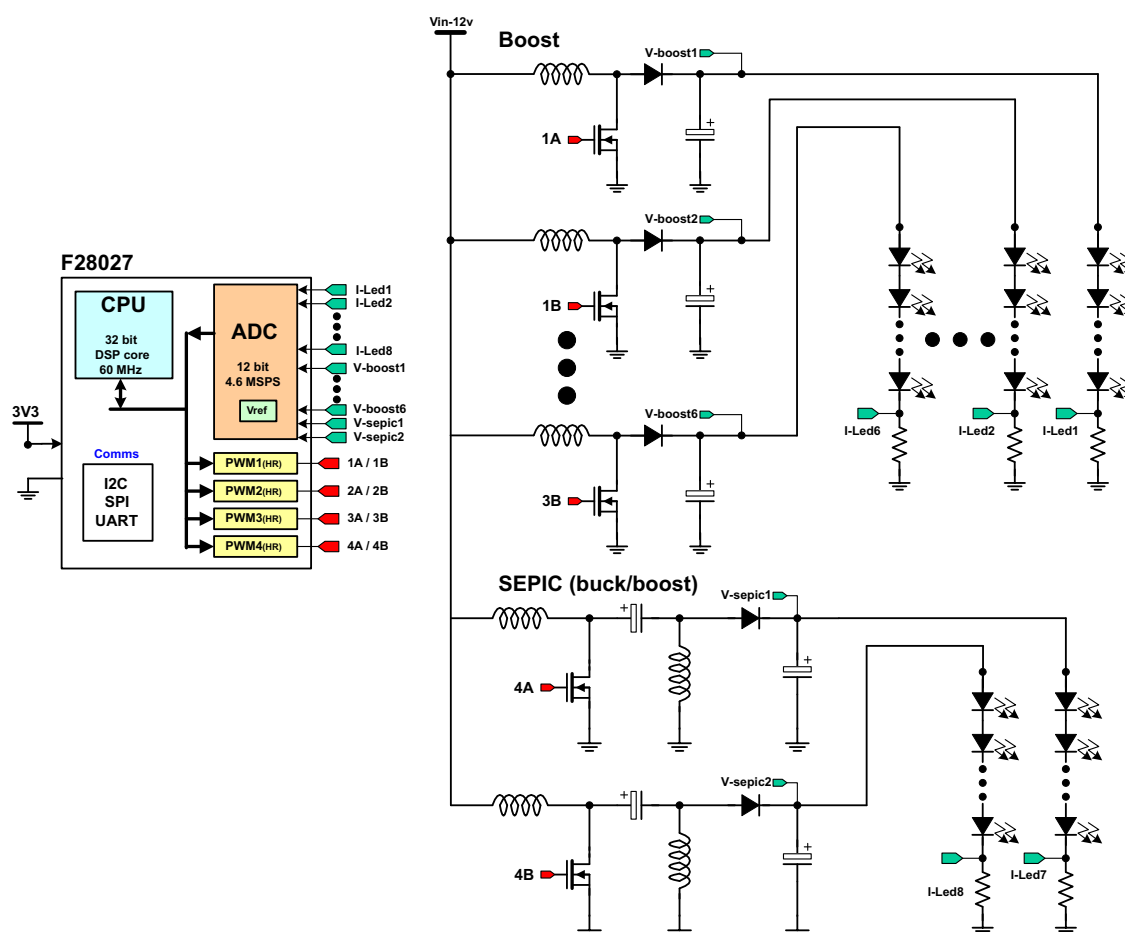


Figure 4. Multi-DC/DC Color LED Kit Circuit Diagram

4.2 Jumpers, Connectors, and Switches

Table 6 lists the jumpers, connectors, and switches available on the board. Figure 5 shows the location of these items with help of a board image.

Table 6. Description of Jumpers, Connectors, and Switches

COMPONENT	DESCRIPTION
[Main]-BS1	Banana jack for primary power rail DC input
[Main]-BS2, BS3	Banana jack for ground connection
[Main]-H1	100-pin DIM100 controlCARD socket
[Main]-J1	ADC-B4 Mux, used to select the input signal for ADC-B4. Place a jumper across pins 1-2 to select V-Led-4B. Place a jumper across pins 2-3 to select VDCin-meas.
[Main]-J2	JTAG enable jumper, populating the jumper enables JTAG connection to the microcontroller. The jumper needs to be unpopulated when booting from Flash, SCI, or another medium.
[Main]-TB1-TB8	Terminal blocks used to connect the output of the DC/DC power stages to a load, such as an LED panel.
[M1]-J1	Demo-mode enable jumper. This jumper connects the primary and auxiliary power rails together to allow board operation from a single 12-V DC supply. For more information, see Section 3.2.
[M1]-JP1	Auxiliary 12-V DC input. This connector is designed to connect up with the 12-V power supply included with this kit and supplies power to the auxiliary power rail powering the C2000 MCU and support chips.
[M1]-SW1	Power switch for the auxiliary 12-V DC input. This switch determines whether power is passed to the auxiliary power stage from the auxiliary 12-V DC input. The auxiliary power rail can still be powered from the primary power rail if the demo mode enable jumper, [M1]-J1, is populated.
[M6]-J2	External JTAG connector. This connector gives access to the JTAG emulation pins. If external emulation is desired, place a jumper across [M6]-J5 and connect the emulator to the board. However, a USB connector still needs to be connected to [M2]-JP1 to power the emulation logic.
[M6]-J4	FTDI UART enable jumper. Populate this jumper when using the FTDI chip as a UART (for example, when using a GUI to interact with the MCU).
[M6]-J5	Onboard emulation disable jumper: Place a jumper here to disable the onboard emulator and give access to the external interface.
[M6]-JP1	USB connector for on-board JTAG emulation and SCI (UART) communication.

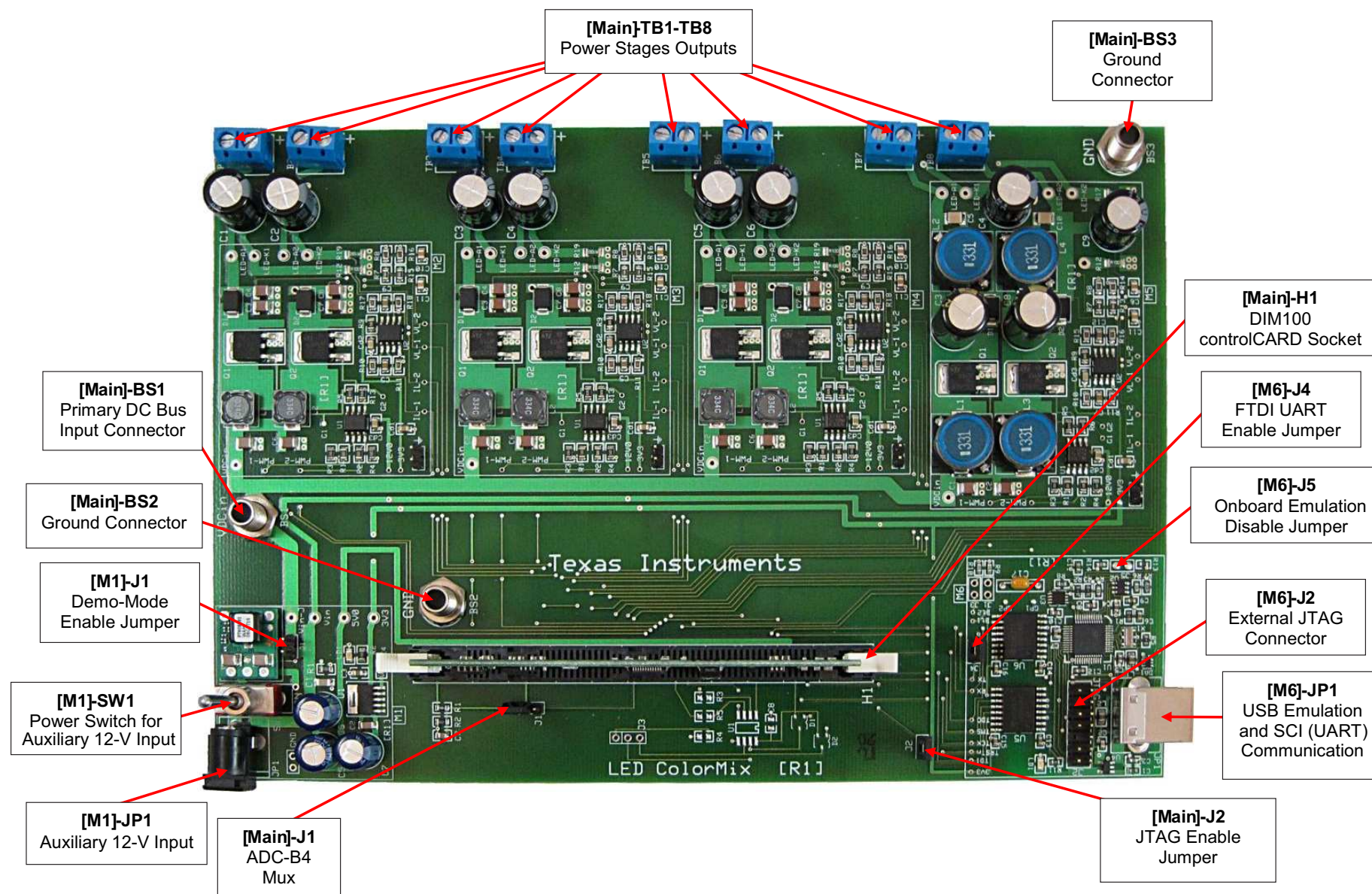


Figure 5. Multi-DC/DC Color LED Board Jumpers, Connectors, and Switches Locations

STANDARD TERMS AND CONDITIONS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, or documentation (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms and conditions set forth herein. Acceptance of the EVM is expressly subject to the following terms and conditions.

- 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms and conditions that accompany such Software
- 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

- 2 *Limited Warranty and Related Remedies/Disclaimers:*

- 2.1 These terms and conditions do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
- 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for any defects that are caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI. Moreover, TI shall not be liable for any defects that result from User's design, specifications or instructions for such EVMs. Testing and other quality control techniques are used to the extent TI deems necessary or as mandated by government requirements. TI does not test all parameters of each EVM.
- 2.3 If any EVM fails to conform to the warranty set forth above, TI's sole liability shall be at its option to repair or replace such EVM, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

- 3 *Regulatory Notices:*

- 3.1 *United States*

- 3.1.1 *Notice applicable to EVMs not FCC-Approved:*

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

- 3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- *Reorient or relocate the receiving antenna.*
- *Increase the separation between the equipment and receiver.*
- *Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- *Consult the dealer or an experienced radio/TV technician for help.*

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan are NOT certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】

本開発キットは技術基準適合証明を受けておりません。

本製品のご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。

日本テキサス・インスツルメンツ株式会社

東京都新宿区西新宿 6 丁目 2 4 番 1 号

西新宿三井ビル

3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_02.page

4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMS are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMS, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

- 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY WRITTEN DESIGN MATERIALS PROVIDED WITH THE EVM (AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
- 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS AND CONDITIONS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT MADE, CONCEIVED OR ACQUIRED PRIOR TO OR AFTER DELIVERY OF THE EVM.

7. *USER'S INDEMNITY OBLIGATIONS AND REPRESENTATIONS.* USER WILL DEFEND, INDEMNIFY AND HOLD TI, ITS LICENSORS AND THEIR REPRESENTATIVES HARMLESS FROM AND AGAINST ANY AND ALL CLAIMS, DAMAGES, LOSSES, EXPENSES, COSTS AND LIABILITIES (COLLECTIVELY, "CLAIMS") ARISING OUT OF OR IN CONNECTION WITH ANY HANDLING OR USE OF THE EVM THAT IS NOT IN ACCORDANCE WITH THESE TERMS AND CONDITIONS. THIS OBLIGATION SHALL APPLY WHETHER CLAIMS ARISE UNDER STATUTE, REGULATION, OR THE LAW OF TORT, CONTRACT OR ANY OTHER LEGAL THEORY, AND EVEN IF THE EVM FAILS TO PERFORM AS DESCRIBED OR EXPECTED.

8. *Limitations on Damages and Liability:*

- 8.1 *General Limitations.* IN NO EVENT SHALL TI BE LIABLE FOR ANY SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL, OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF THESE TERMS AND CONDITIONS OR THE USE OF THE EVMS PROVIDED HEREUNDER, REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. EXCLUDED DAMAGES INCLUDE, BUT ARE NOT LIMITED TO, COST OF REMOVAL OR REINSTALLATION, ANCILLARY COSTS TO THE PROCUREMENT OF SUBSTITUTE GOODS OR SERVICES, RETESTING, OUTSIDE COMPUTER TIME, LABOR COSTS, LOSS OF GOODWILL, LOSS OF PROFITS, LOSS OF SAVINGS, LOSS OF USE, LOSS OF DATA, OR BUSINESS INTERRUPTION. NO CLAIM, SUIT OR ACTION SHALL BE BROUGHT AGAINST TI MORE THAN ONE YEAR AFTER THE RELATED CAUSE OF ACTION HAS OCCURRED.
- 8.2 *Specific Limitations.* IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY WARRANTY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS AND CONDITIONS, OR ANY USE OF ANY TI EVM PROVIDED HEREUNDER, EXCEED THE TOTAL AMOUNT PAID TO TI FOR THE PARTICULAR UNITS SOLD UNDER THESE TERMS AND CONDITIONS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM AGAINST THE PARTICULAR UNITS SOLD TO USER UNDER THESE TERMS AND CONDITIONS SHALL NOT ENLARGE OR EXTEND THIS LIMIT.

9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

10. *Governing Law:* These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2014, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com